

DETAILS

Product Number	CA13269_LAURA-SS-WAS
Family	Laura
Type	Assembly
Color	white
Diameter	21.6 x 21.6 mm
Height	13.1 mm
Style	square
Optic Material	PMMA
Holder Material	PC
Fastening	tape
Status	ready
ROHS Compliant	Yes
Date Updated	25/10/2013



OPTICAL PROPERTIES

LED	Viewing	Light	Effi-	cd/lm	Connector
	Angle	Beam	ciency		
LUXEON Q	Asym deg	Asymmetric	91 %	10.300	-
XP-E	Asymmetric deg	Asymmetric	92 %	11.600	-

4

3

2

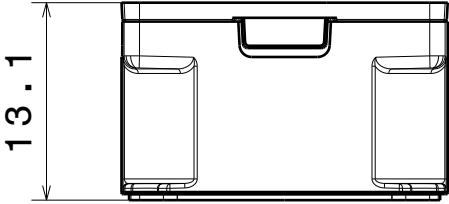
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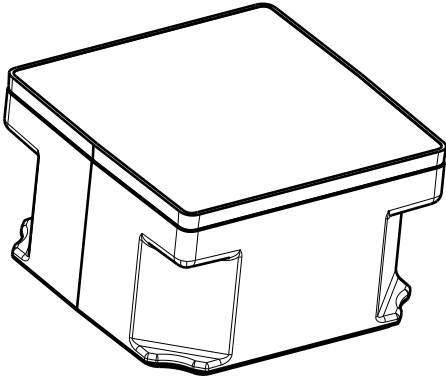
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B

A

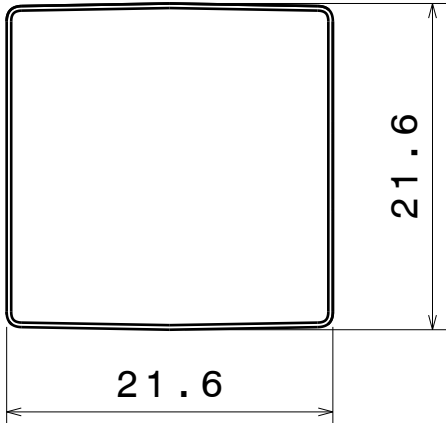


Front View

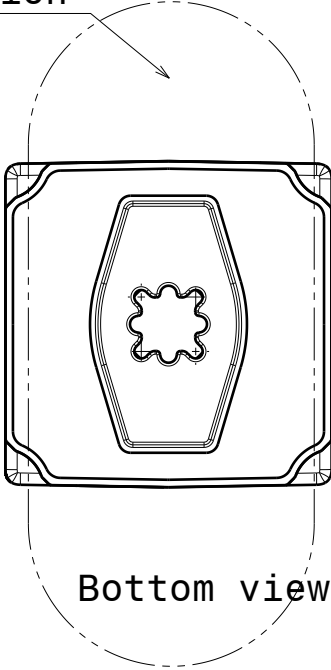


Isometric view

Oval Beam Direction



Top view



Bottom view

4

3

2

1

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Ledil Oy
Salorankatu 10
FIN 24240 SALO
Finland

DRAWN BY
ks

DATE
08.11.2012

DRAWING TITLE
Mechanical Drawing
LAURA-XP

CHECKED BY
as

DATE
-

SIZE
A4

PART NUMBER

REV
001

DESIGNED BY
-

DATE
-

SCALE 2:1

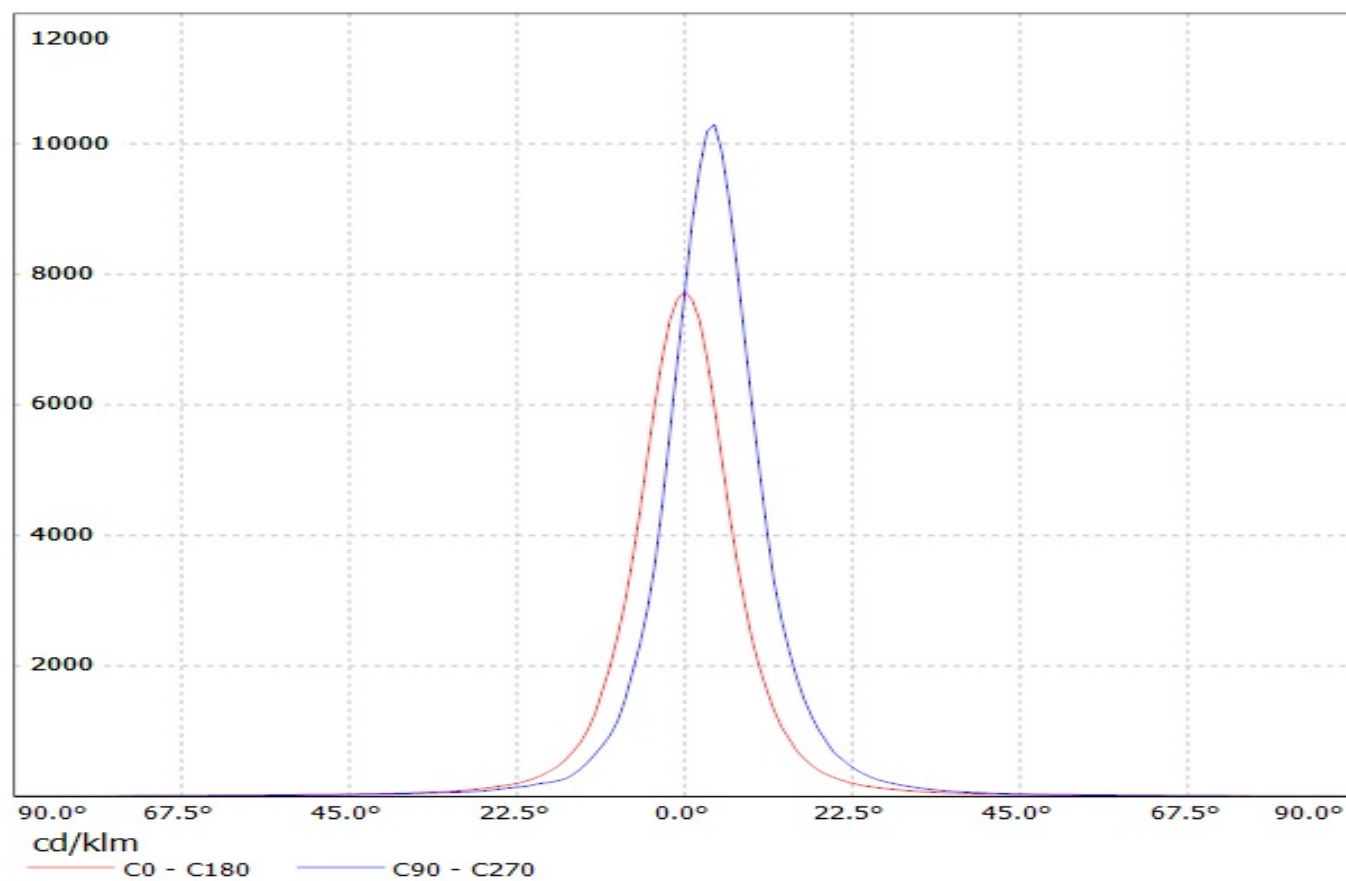
WEIGHT

SHEET 1/1

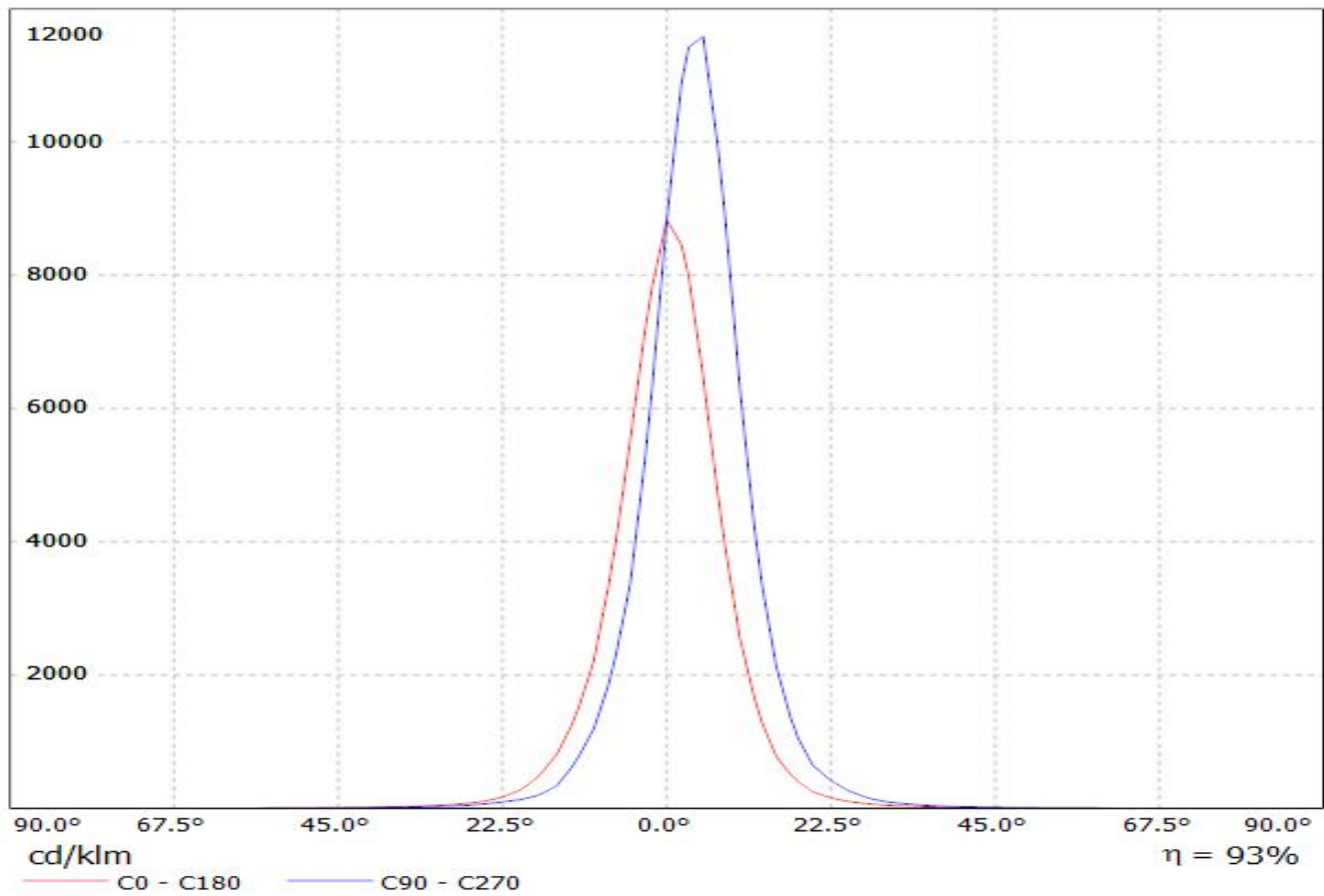
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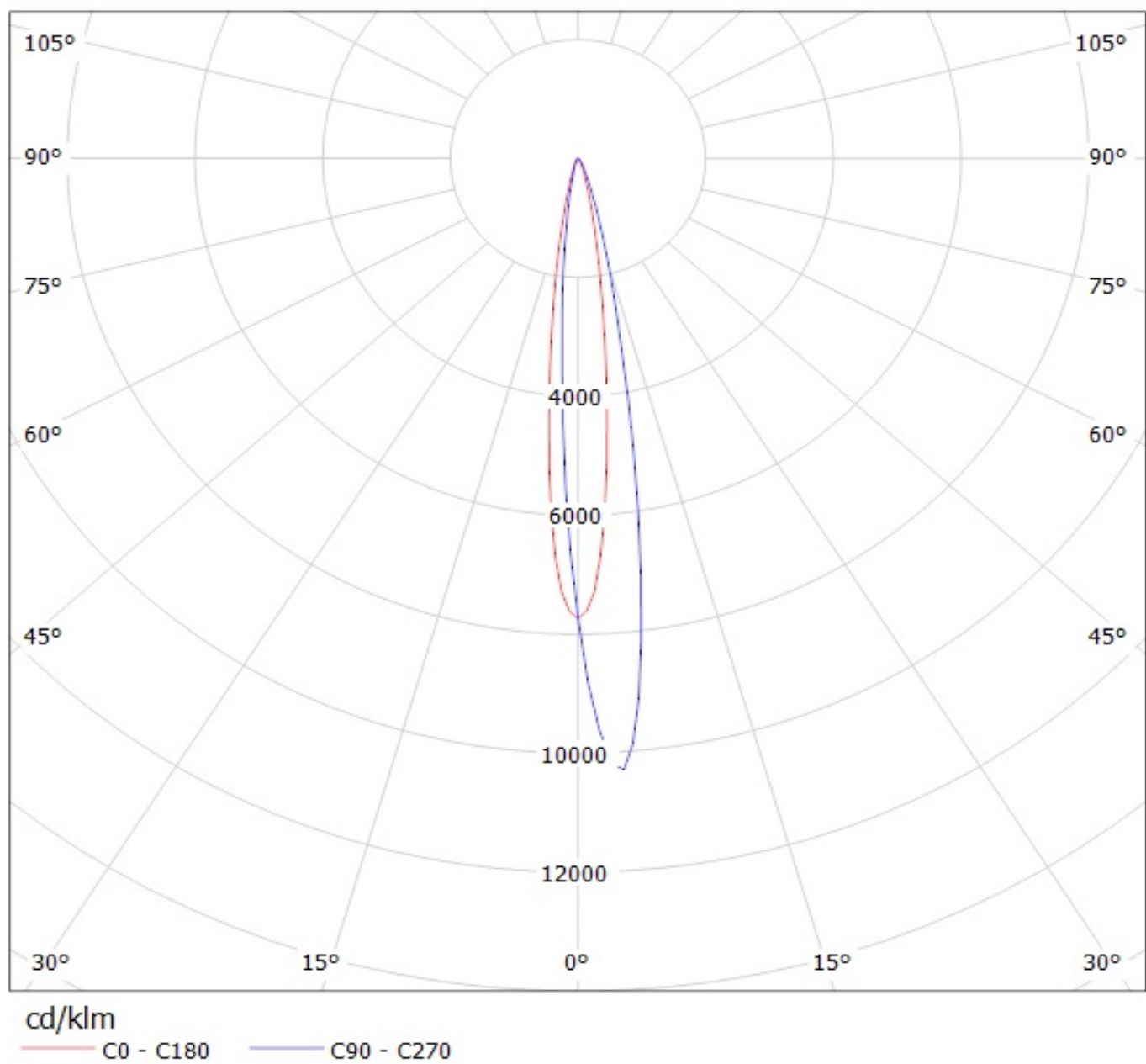
Luminaire: LEDiL Oy CA13269_LAURA-SS-WAS_(LUXEON_Q) Eff: 91%
Lamps: 1 x LUXEON_Q_(LHQ-3080)_79.56lm@250mA_P=0.753249W_I=249.9mA



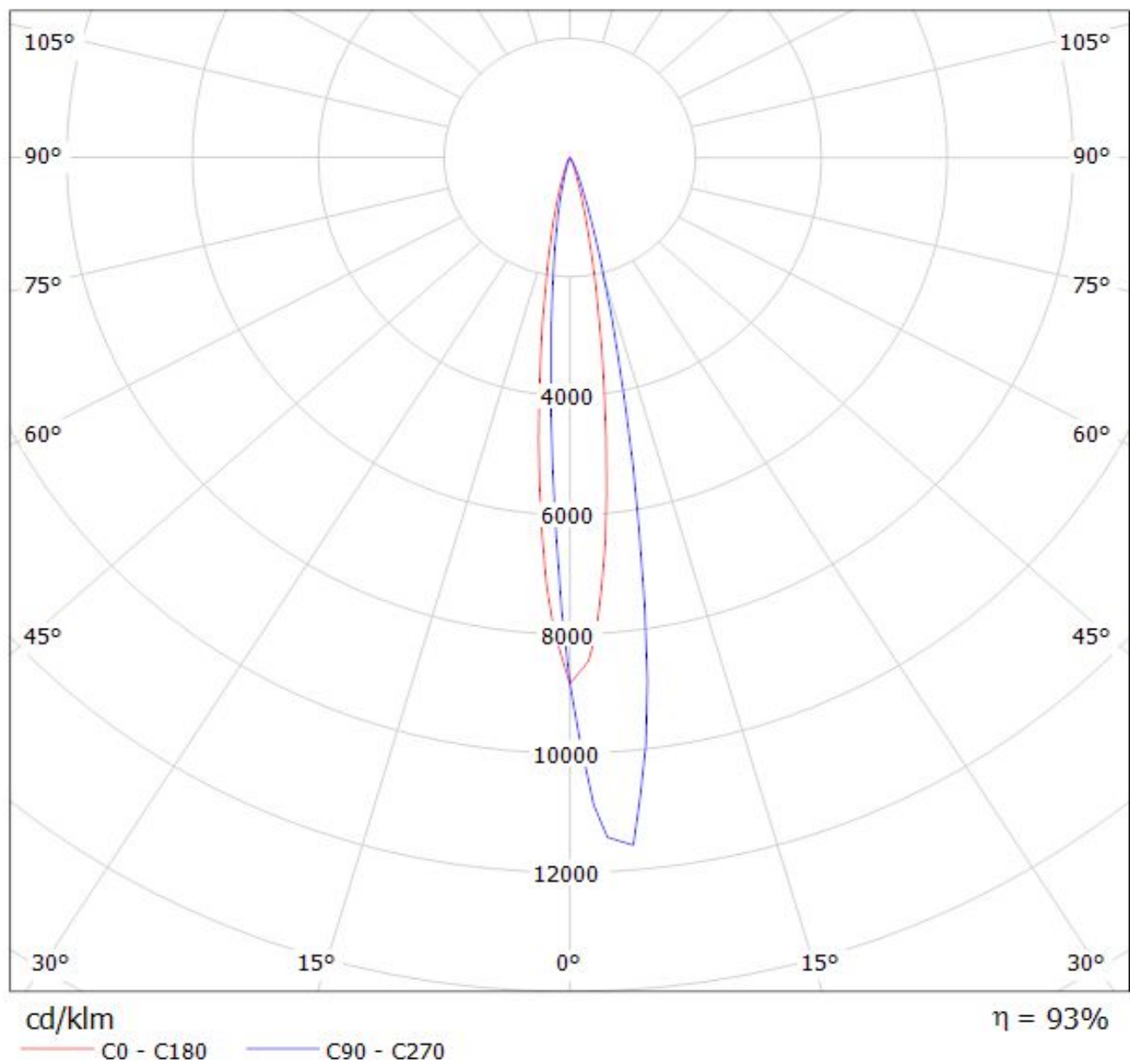
Luminaire: Ledi Oy CA13269 LAURA-SS-WAS_(XP-E) Efficiency=92%
Lamps: 1 x Cree XP-E 70lm @ 250mA



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Luminaire: Ledil Oy CA13269_LAURA-SS-WAS_(XP-E) Efficiency=92%
Lamps: 1 x Cree XP-E 70lm @ 250mA



NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

GENERAL INFORMATION

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit board weaken the strength of the tape.

NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.